

# NCP584

## Product Preview

### 3-Mode 200 mA LDO Regulator

The NCP584 series of low drop out regulators are designed for portable battery powered applications which require precise output voltage accuracy, low supply current, and high ripple rejection. These devices feature an enable function which lowers current consumption significantly and are offered in the SOT23-5 package.

This series of devices have three modes. Chip Enable (CE mode), Fast Transient Mode (FT mode), and Low Power Mode (LP mode). Both the FT and LP mode are utilized via the ECO pin.

#### Features

- Low Dropout Voltage of 300 mV at 200 mA, Output Voltage = 1.0 V  
200 mV at 200 mA, Output Voltage = 1.5 V  
140 mV at 200 mA, Output Voltage = 3.0 V
- Excellent Line and Load Regulation
- High Output Voltage Accuracy of  $\pm 2\%$  ( $\pm 3\%$  LP mode)
- Ultra-Low Supply Current of:  
3.5  $\mu$ A (LP mode, Output Voltage  $\leq 1.5$  V)  
40  $\mu$ A (FT mode)
- Excellent Power Supply Rejection Ratio
- Low Temperature Drift Coefficient on the Output Voltage

#### Typical Applications

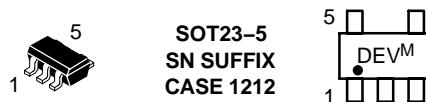
- Portable Equipment
- Hand-Held Instrumentation
- Camcorders and Cameras



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#### MARKING DIAGRAM



DEV = Device Code  
M = Date Code

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

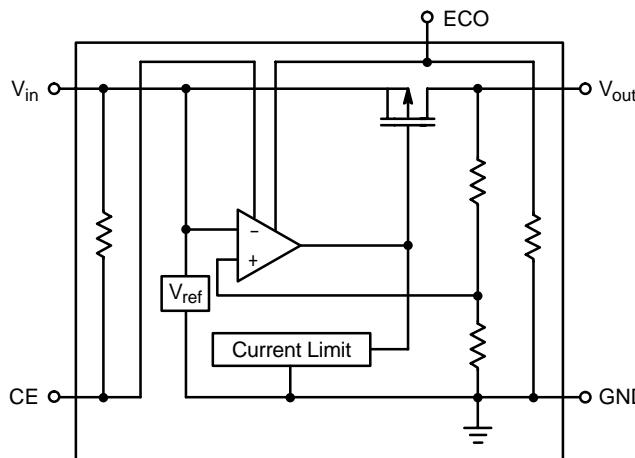


Figure 1. Simplified Block Diagram for Active Low

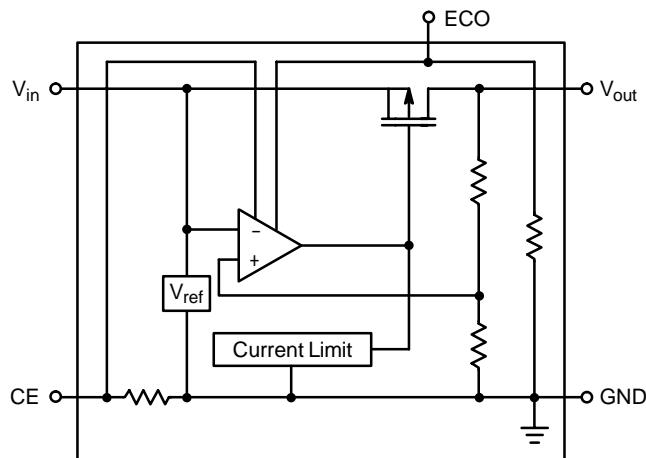


Figure 2. Simplified Block Diagram for Active High

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

**PIN FUNCTION DESCRIPTION**

SOT23-5	Pin Name	Description
1	V <sub>in</sub>	Power supply input voltage.
2	GND	Power supply ground.
3	CE or CE	Chip enable pin.
4	ECO	Mode alternative pin.
5	V <sub>out</sub>	Regulated output voltage.

**MAXIMUM RATINGS**

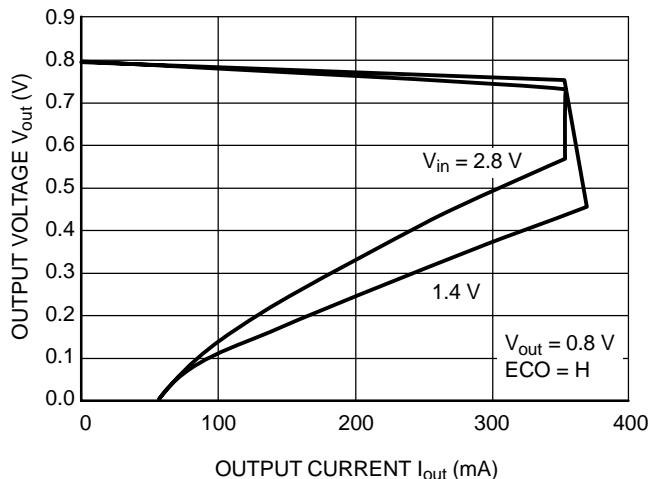
Rating	Symbol	Value	Unit
Input Voltage	V <sub>in</sub>	6.5	V
Input Voltage (CE or CE Pin)	V <sub>CE</sub>	-0.3 to V <sub>in</sub> +0.3	V
Input Voltage (ECO Pin)	V <sub>ECO</sub>	-0.3 to V <sub>in</sub> +0.3	V
Output Voltage	V <sub>out</sub>	-0.3 to V <sub>in</sub> +0.3	V
Output Current	I <sub>out</sub>	250	mA
Power Dissipation	P <sub>D</sub>	250	mW
Operating Junction Temperature Range	T <sub>J</sub>	-40 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	+150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

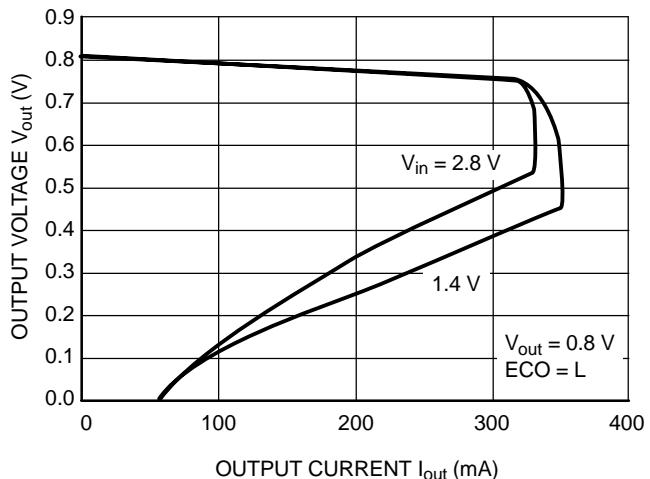
**ELECTRICAL CHARACTERISTICS** (V<sub>in</sub> = V<sub>out</sub> + 1.0 V, T<sub>A</sub> = 25°C, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Input Voltage	V <sub>in</sub>	1.4	—	6.0	V
Output Voltage (1.0 μA ≤ I <sub>out</sub> ≤ 30 mA) V <sub>ECO</sub> = V <sub>in</sub> V <sub>ECO</sub> = GND	V <sub>out</sub>	V <sub>out</sub> X 0.980 V <sub>out</sub> X 0.970	— —	V <sub>out</sub> X 1.020 V <sub>out</sub> X 1.030	V
Line Regulation (I <sub>out</sub> = 30 mA, V <sub>out</sub> + 0.5 V ≤ V <sub>in</sub> ≤ 6.0 V) FT Mode V <sub>ECO</sub> = V <sub>in</sub> LP Mode V <sub>ECO</sub> = GND	Reg <sub>line</sub>	— —	0.05 0.10	0.20 0.30	%/V
Load Regulation FT Mode (1.0 mA ≤ I <sub>out</sub> ≤ 200 mA), V <sub>ECO</sub> = V <sub>in</sub> LP Mode (1.0 mA ≤ I <sub>out</sub> ≤ 100 mA), V <sub>ECO</sub> = GND	Reg <sub>load</sub>	— —	20 10	40 40	mV
Dropout Voltage (I <sub>out</sub> = 200 mA) 0.8 ≤ V <sub>out</sub> ≤ 0.9 V 1.0 ≤ V <sub>out</sub> ≤ 1.4 V 1.5 ≤ V <sub>out</sub> ≤ 2.5 V	V <sub>DO</sub>	— —	0.40 0.30 0.20	0.70 0.50 0.30	mV
Power Supply Current (I <sub>out</sub> = 0 mA) FT Mode, V <sub>ECO</sub> = V <sub>in</sub> LP Mode, V <sub>ECO</sub> = GND V <sub>out</sub> ≤ 1.5 V V <sub>out</sub> ≤ 1.6 V	I <sub>supply</sub>	— —	40 3.5 4.5	70 6.0 8.0	μA
Output Current (V <sub>in</sub> − V <sub>out</sub> = 0.5 V) V <sub>in</sub> ≥ 1.5 V, V <sub>out</sub> ≤ 1.0 V	I <sub>out</sub>	200	—	—	mA
Quiescent Current (V <sub>CE</sub> = GND)	I <sub>Q</sub>	—	0.1	1.0	μA
Output Short Circuit Current (V <sub>out</sub> = 0 V)	I <sub>lim</sub>	—	50	—	mA
Enable Input Threshold Voltage High, ECO Input Voltage = High Low, ECO Input Voltage = Low	V <sub>th<sub>enh</sub></sub> V <sub>th<sub>enl</sub></sub>	1.0 0	— —	V <sub>in</sub> 0.3	V

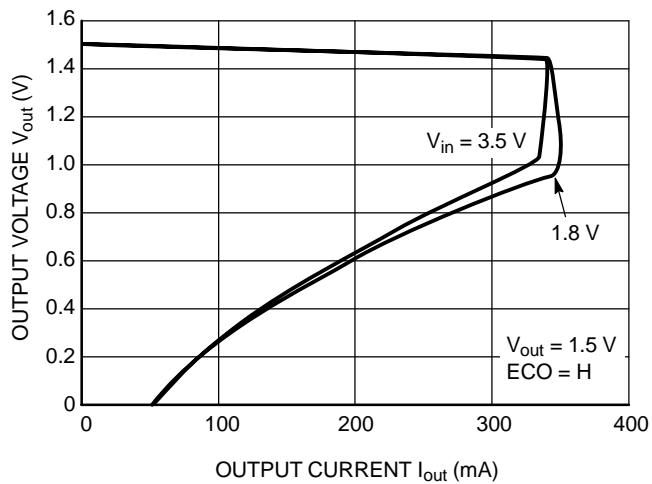
## TYPICAL CHARACTERISTICS



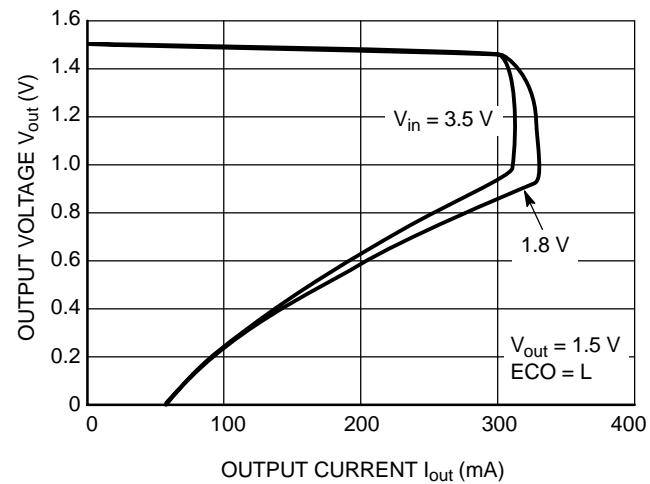
**Figure 3. Output Voltage vs. Output Current**



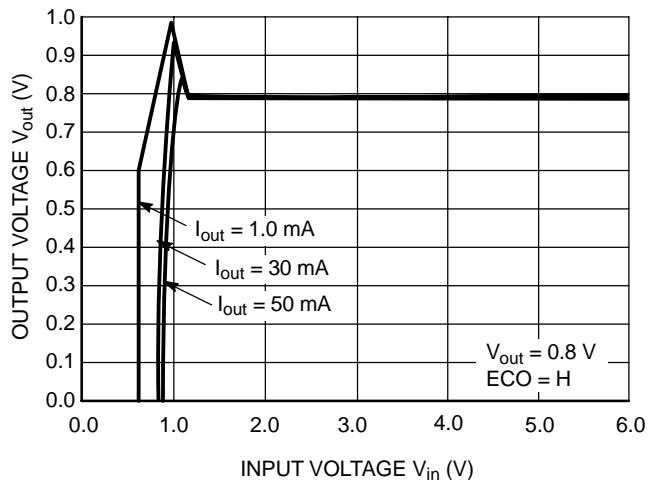
**Figure 4. Output Voltage vs. Output Current**



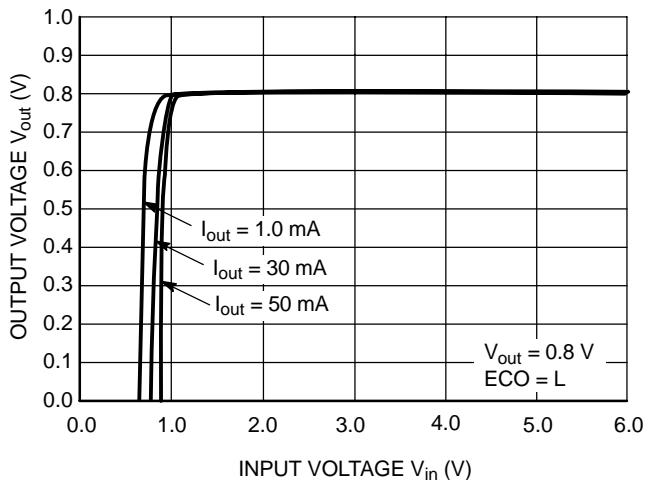
**Figure 5. Output Voltage vs. Output Current**



**Figure 6. Output Voltage vs. Output Current**

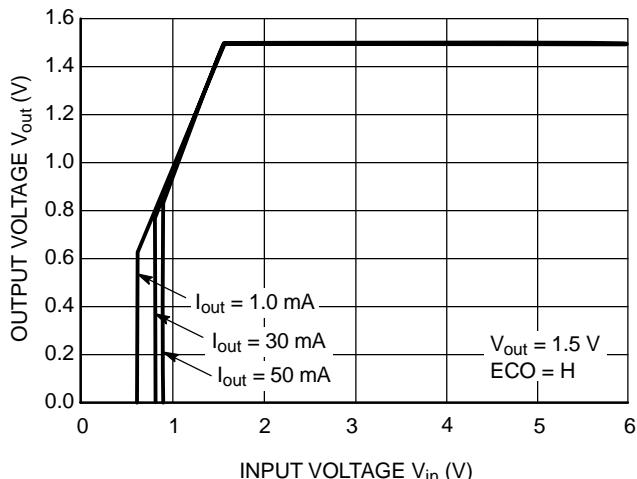


**Figure 7. Output Voltage vs. Input Voltage**

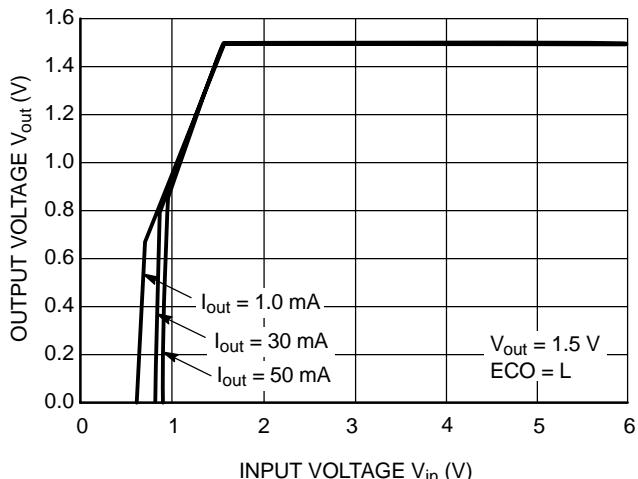


**Figure 8. Output Voltage vs. Input Voltage**

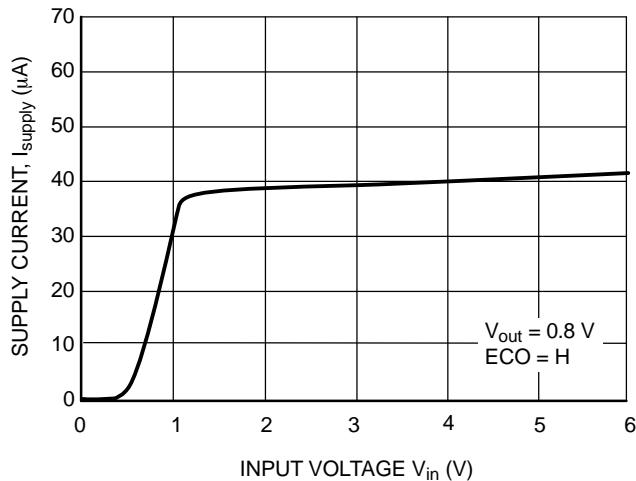
**TYPICAL CHARACTERISTICS**



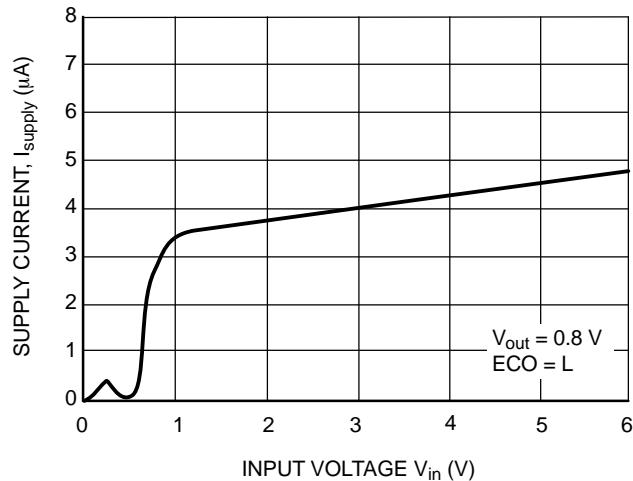
**Figure 9. Output Voltage vs. Input Voltage**



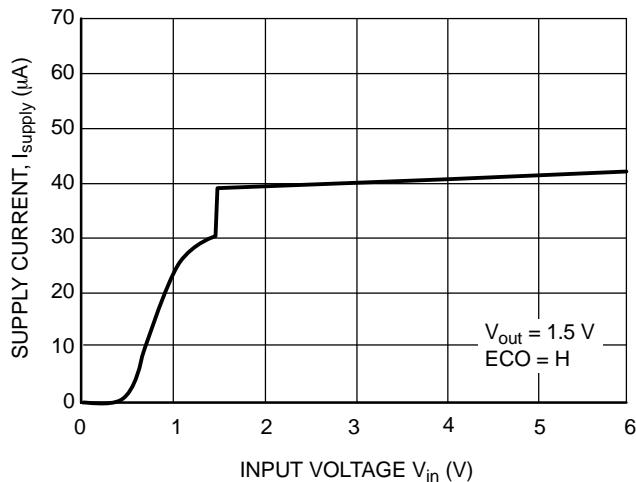
**Figure 10. Output Voltage vs. Input Voltage**



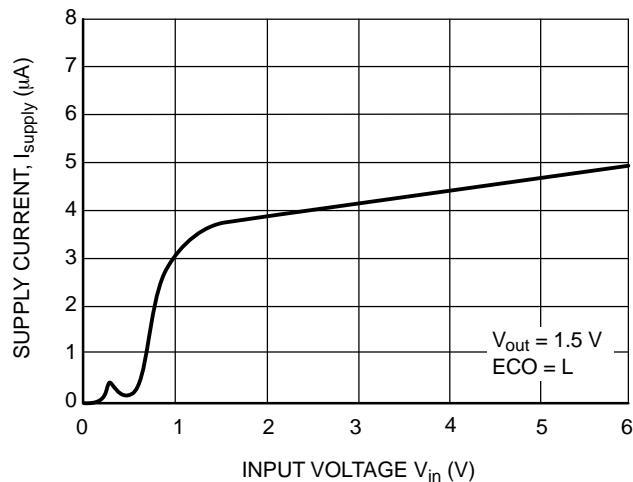
**Figure 11. Power Supply Current vs. Input Voltage**



**Figure 12. Power Supply Current vs. Input Voltage**



**Figure 13. Power Supply Current vs. Input Voltage**



**Figure 14. Power Supply Current vs. Input Voltage**

## TYPICAL CHARACTERISTICS

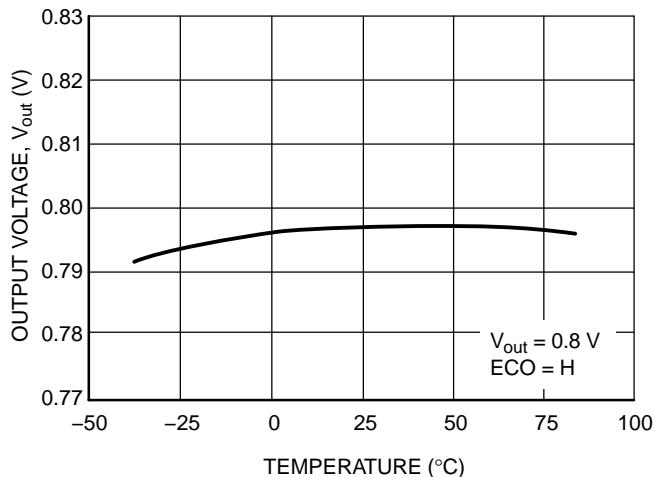


Figure 15. Output Voltage vs. Temperature

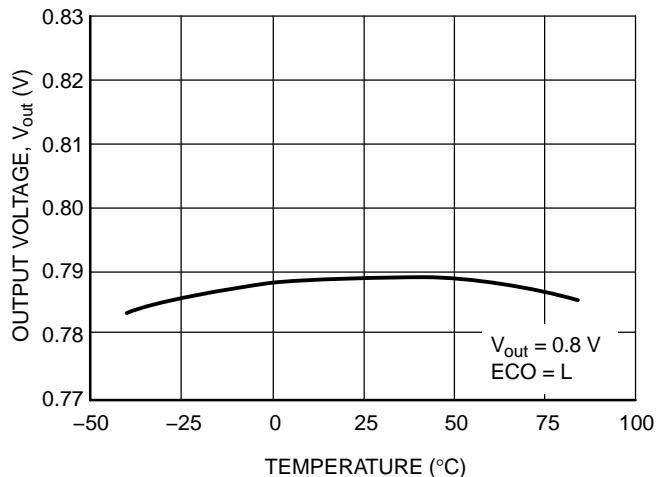


Figure 16. Output Voltage vs. Temperature

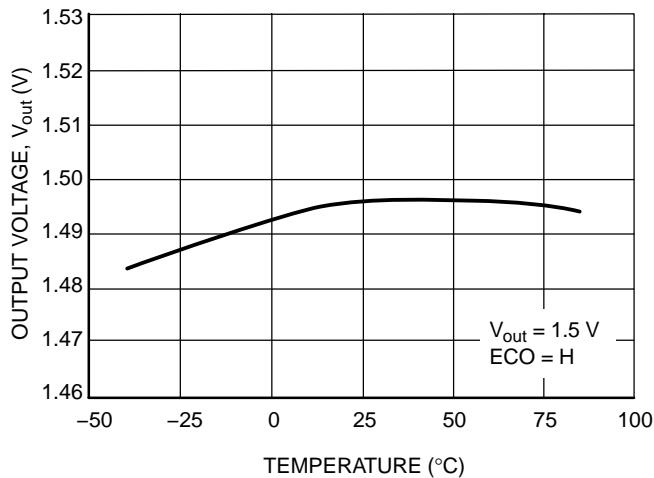


Figure 17. Output Voltage vs. Temperature

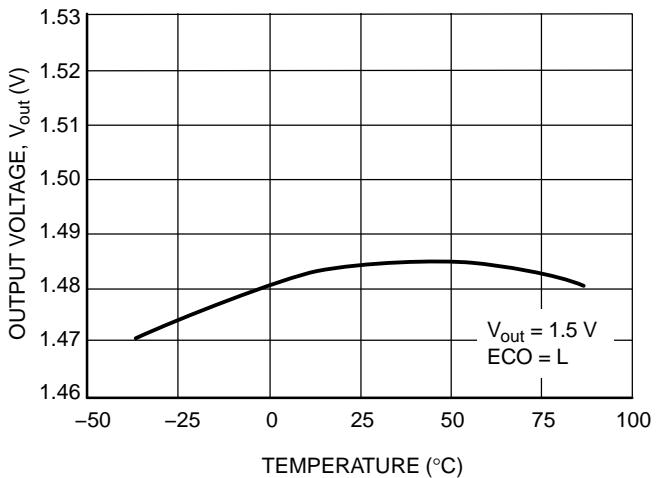


Figure 18. Output Voltage vs. Temperature

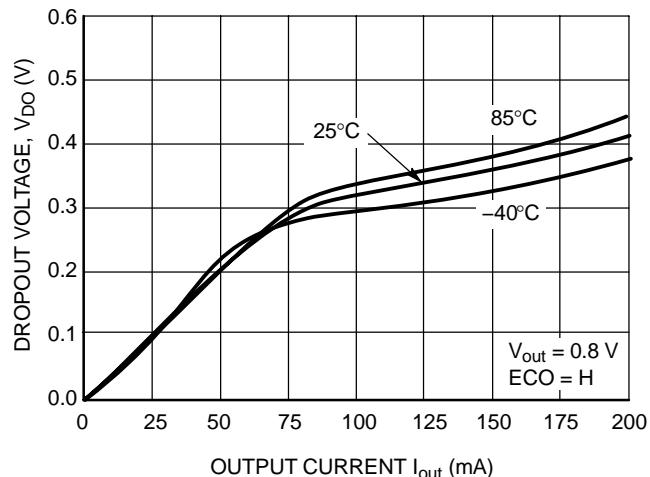


Figure 19. Dropout Voltage vs. Output Current

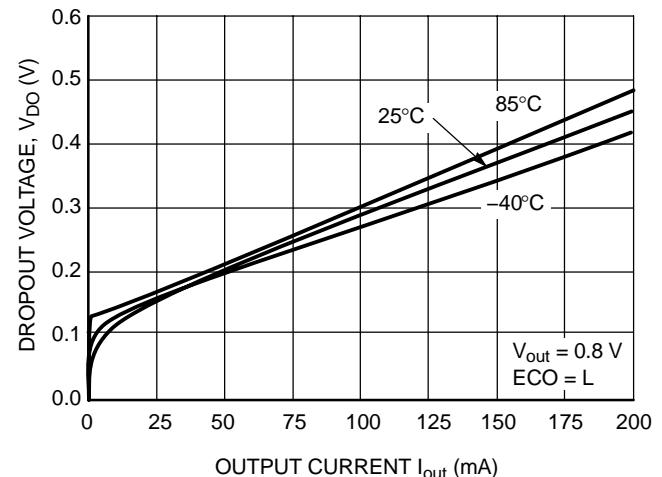


Figure 20. Dropout Voltage vs. Output Current

## TYPICAL CHARACTERISTICS

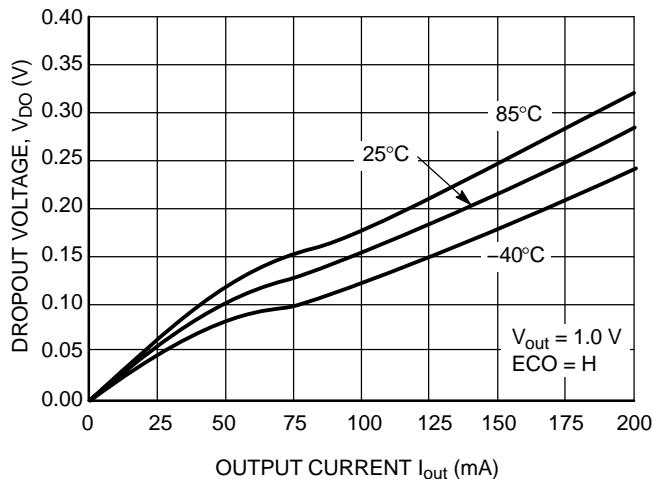


Figure 21. Dropout Voltage vs. Output Current

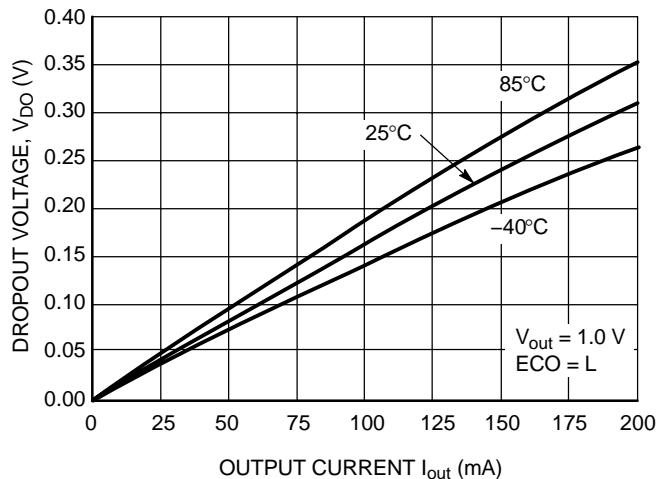


Figure 22. Dropout Voltage vs. Output Current

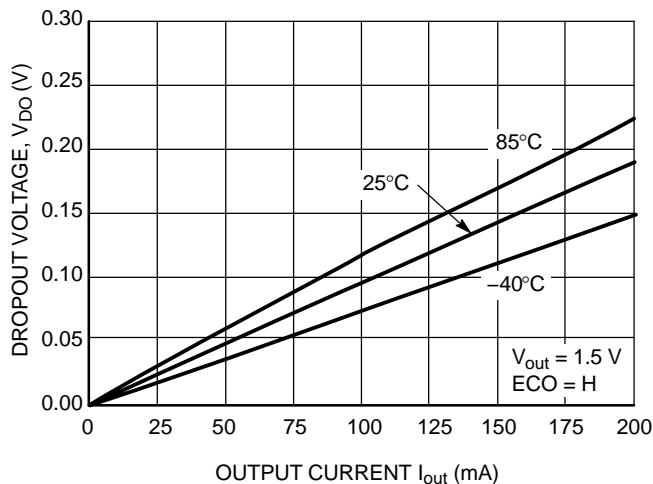


Figure 23. Dropout Voltage vs. Output Current

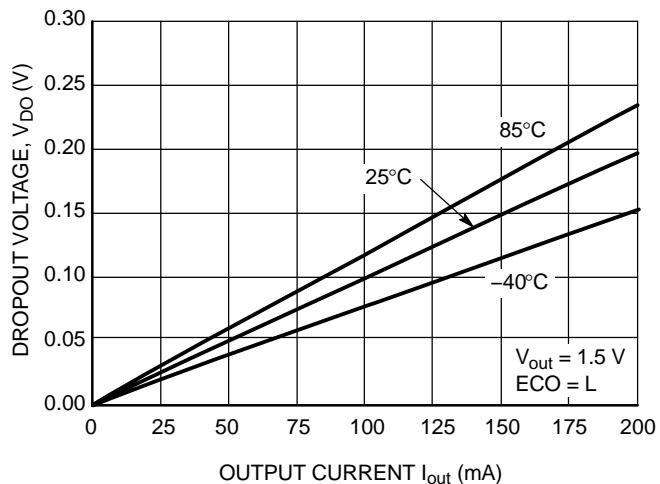


Figure 24. Dropout Voltage vs. Output Current

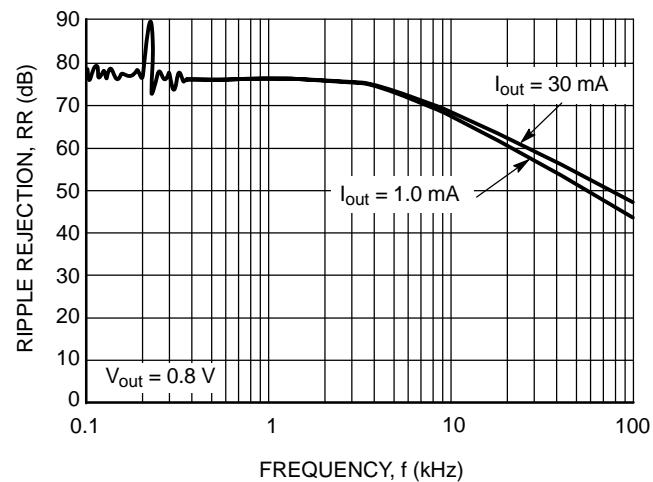


Figure 25. Ripple Rejection vs. Frequency

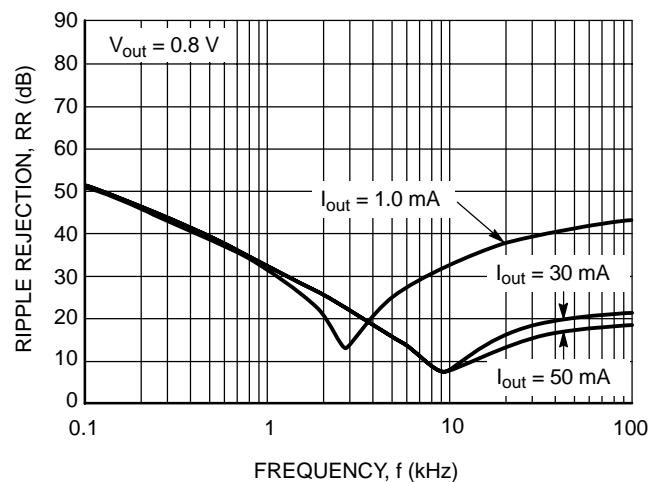
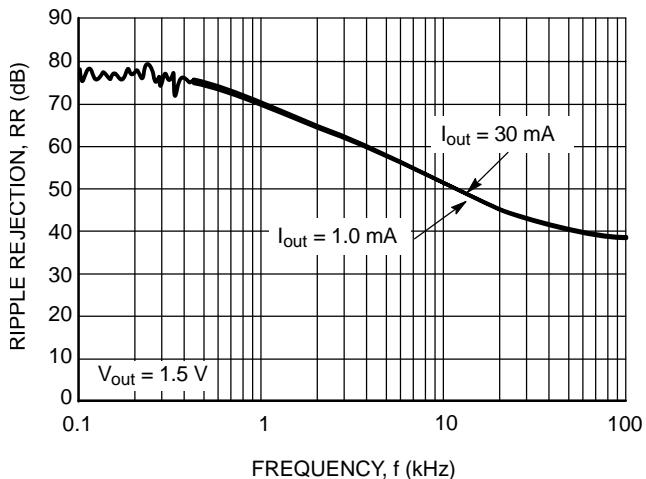
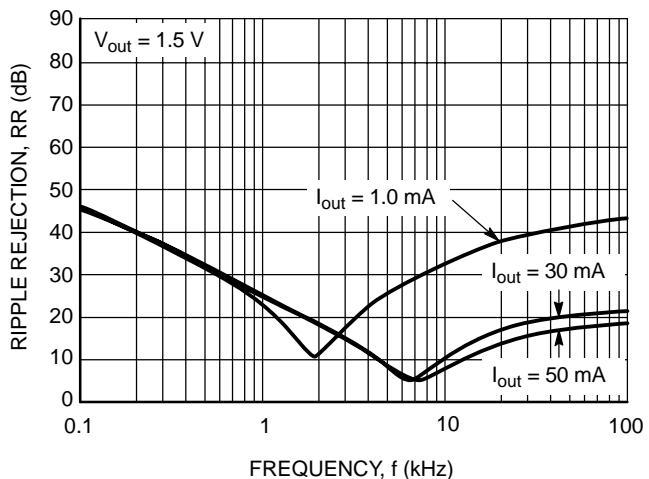


Figure 26. Ripple Rejection vs. Frequency

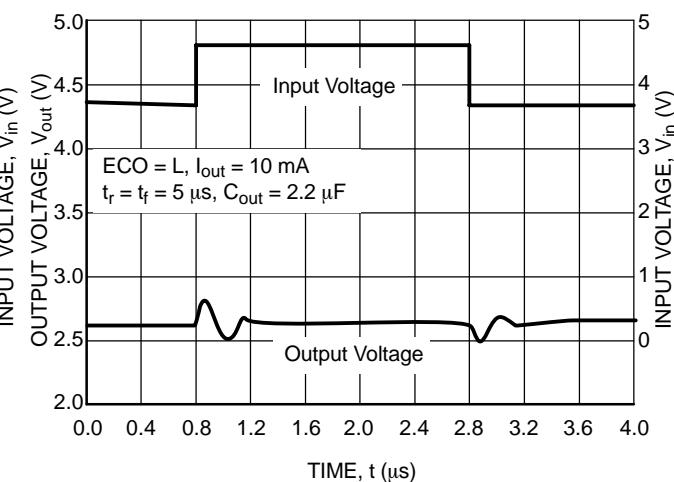
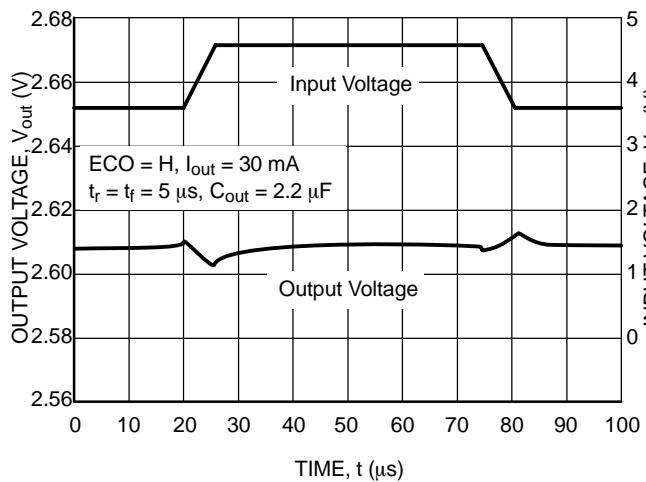
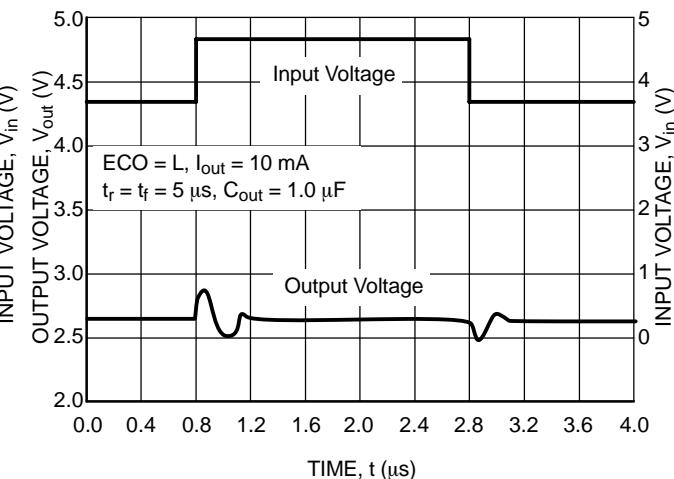
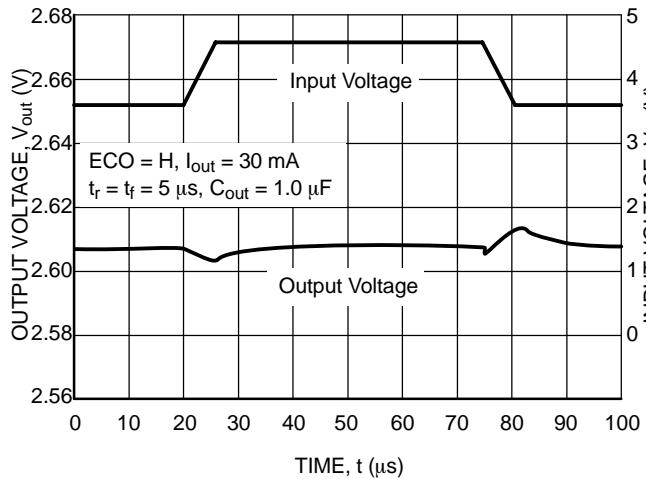
## TYPICAL CHARACTERISTICS



**Figure 27. Ripple Rejection vs. Frequency**



**Figure 28. Ripple Rejection vs. Frequency**



**Figure 29. Input Transient Response ( $V_{out} = 2.6$  V)**

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## TYPICAL CHARACTERISTICS

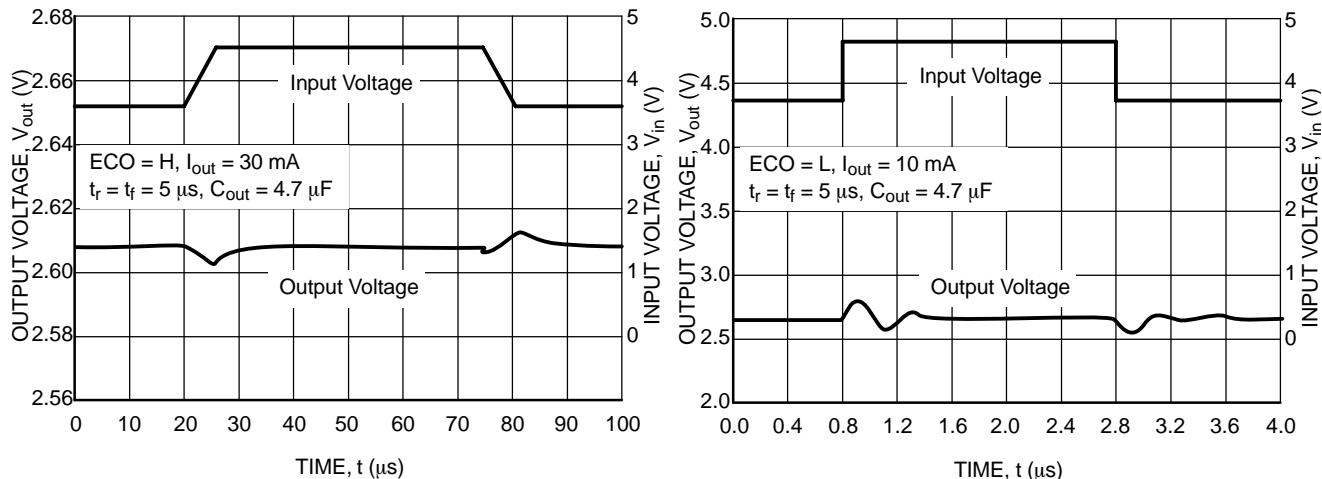


Figure 29. (continued) Input Transient Response ( $V_{out} = 2.6 \text{ V}$ )

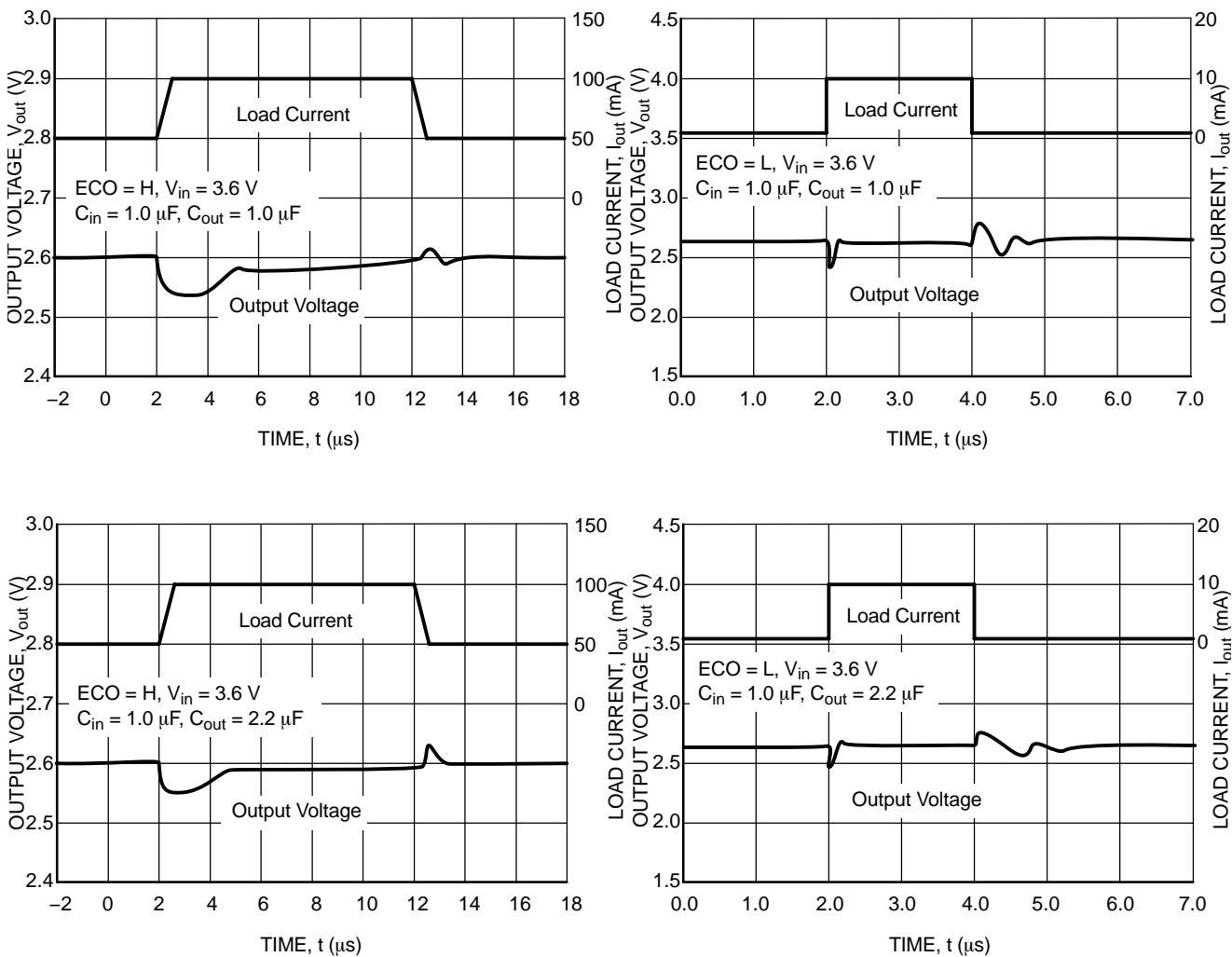
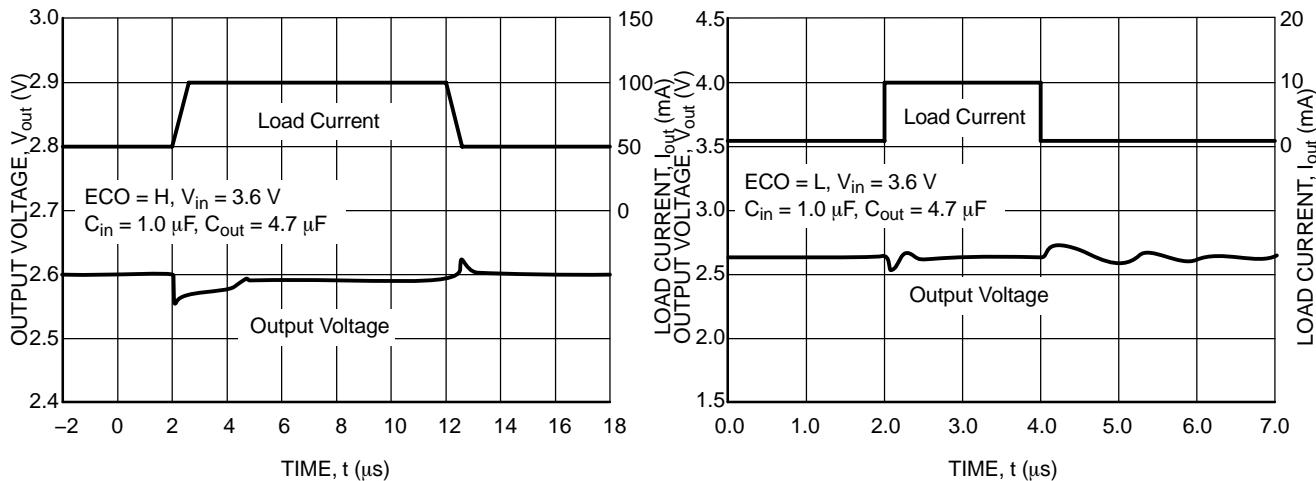
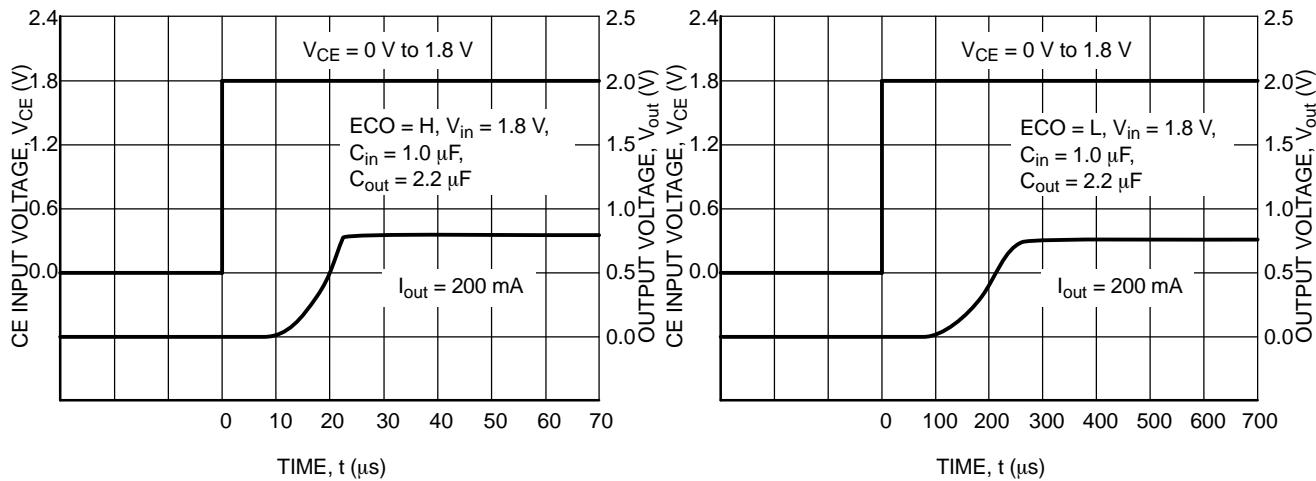


Figure 30. Load Transient Response ( $V_{out} = 2.6 \text{ V}$ )

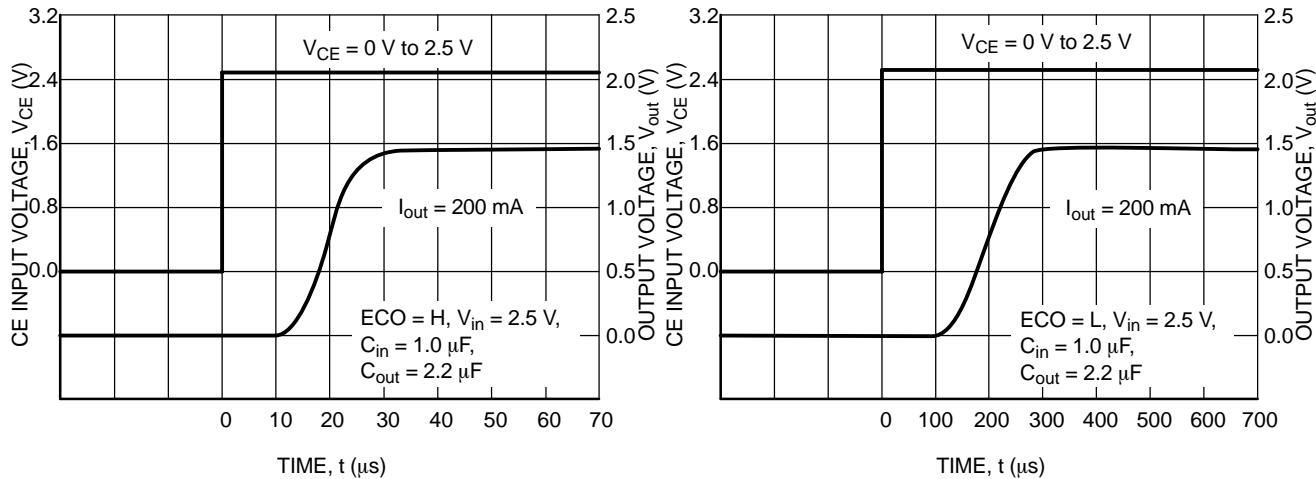
**TYPICAL CHARACTERISTICS**



**Figure 30. (continued) Load Transient Response ( $V_{out} = 2.6$  V)**

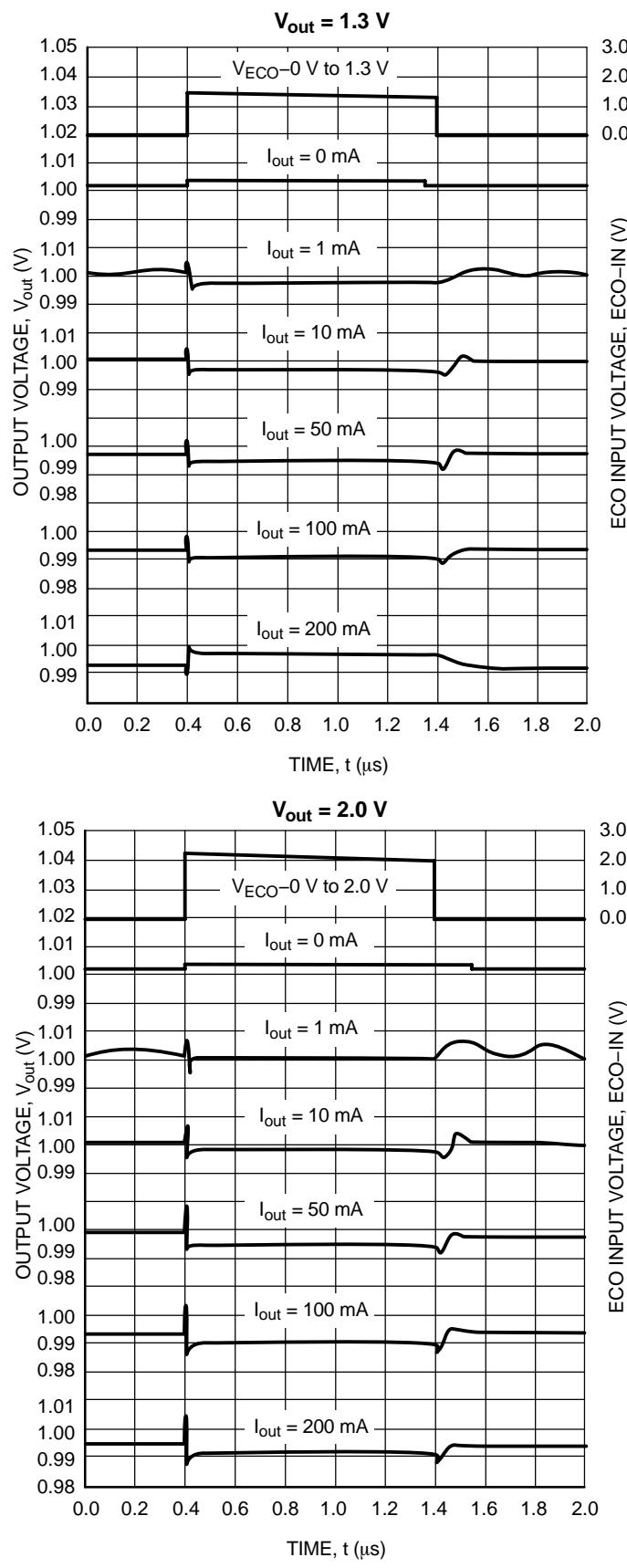


**Figure 31. Turn-On/Off Speed with CE Pin ( $V_{out} = 0.8$  V)**



**Figure 32. Turn-On/Off Speed with CE Pin ( $V_{out} = 1.5$  V)**

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**Figure 33. Output Voltage at Mode Alternative Point**  
**(C<sub>in</sub> = 1.0 μF, C<sub>out</sub> = 2.2 μF, 8.0 V, V<sub>out</sub> = 1.0 V)**

# NCP584

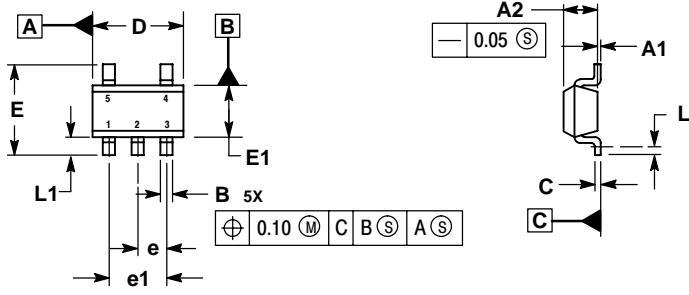
## ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Package	Shipping <sup>†</sup>
NCP584HSN09T1	0.9	109	SOT23-5	3000 Tape & Reel
NCP584HSN12T1	1.2	112	SOT23-5	3000 Tape & Reel
NCP584HSN18T1	1.8	118	SOT23-5	3000 Tape & Reel
NCP584LSN09T1	0.9	009	SOT23-5	3000 Tape & Reel
NCP584LSN12T1	1.2	012	SOT23-5	3000 Tape & Reel
NCP584LSN18T1	1.8	018	SOT23-5	3000 Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## PACKAGE DIMENSIONS

SOT23-5  
SN SUFFIX  
CASE 1212-01  
ISSUE O



## NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DATUM C IS A SEATING PLANE.

DIM	MILLIMETERS	
	MIN	MAX
A1	0.00	0.10
A2	1.00	1.30
B	0.30	0.50
C	0.10	0.25
D	2.80	3.00
E	2.50	3.10
E1	1.50	1.80
e	0.95 BSC	
e1	1.90 BSC	
L	0.20	---
L1	0.45	0.75

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